

**Amendments to the Specification:**

Page 3, after "DISCLOSURE OF THE INVENTION:", please replace paragraphs 1 and 2 (bridging pages 3-4), as follows:

According to an aspect of the present invention, ~~as described in claim 1,~~ there is provided a high-frequency current suppressor comprising a flexible member capable of being attached to a cable.

~~As described in claim 2 it~~ It is preferable that the flexible member comprises a break, which elongates over all length along an axial direction of the cable.

Pages 4-5, starting with first full paragraph on page 4 to the word "suppressor" on page 5, please replace as follows:

~~As described in claim 3, the~~ The high-frequency current suppressor may comprise at least two layers which consist of a high-frequency current suppressing layer and at least one outer layer.

~~As described in claim 4, the~~ The outer layer may be consisting of either a molded resin or a molded metal, or combination of the molded resin and the molded metal.

~~As described in claim 5, the~~ The high-frequency current suppressor may be consisting of composite magnetic material which comprises soft magnetic powder obtained by flattening alloy powder including at least Fe, Si, Al, and binding material.

~~As described in claim 6, the~~ The high-frequency current suppressor may be consisting of composite magnetic material which comprises soft magnetic powder obtained by flattening alloy powder including at least Ni, Fe, and binding material.

~~As described in claim 7, the~~ The high-frequency current suppressor may be consisting of magnetic loss thin film which comprises a first member consisting of at least any one of Fe, Co, Ni, or mixture thereof and a second member consisting of insulating material including at least more than one kinds of elements other than Fe, Co, Ni.

~~As described in claim 8, an~~ An earphone system for use in a terminal of mobile communication may be provided with the high-frequency current suppressor as described above ~~as claimed in any one of the claims 1 through 7.~~

~~Besides,~~ In addition, the "earphone system" depicted in the present invention includes not only a system having one earphone (for use in a single ear) or two earphones (for use in

both ears) but also another system having, what we call, a headphone combining two earphones (for use in both ears) and a head band etc. [[.]]

According to another aspect of the present invention, ~~as described in claim 9,~~ there is provided an earphone system comprising a connection plug connected to an output terminal of an electronic equipment, an earphone, and a signal cable for connecting the connection plug with the earphone, wherein a high-frequency current suppressor consisting of soft magnetic material is added at least partially to any one of the connection plug, the earphone, and the signal cable.

~~As described in claim 10,~~ a A part or a whole of outer circumference of the signal cable may be covered by the high-frequency current suppressor.

~~As described in claim 11,~~ a A part or a whole of outer circumference of an outer conductor of the signal cable may be covered by the high-frequency current suppressor.

~~As described in claim 12,~~ the The high-frequency current suppressor may be provided near a portion where the signal cable and the earphone are connected to each other.

~~As described in claim 13, the~~ The high-frequency current suppressor may be included inside the earphone.

~~As described in claim 14, the~~ The earphone system may further comprise a microphone.

~~As described in claim 15, the~~ The high-frequency current suppressor may be included inside the microphone.

~~As described in claim 16, a~~ A housing of the earphone or the microphone may be formed by the high-frequency current suppressor.

Page 6, first, second and third full paragraphs, replace as follows:

~~As described in claim 17, the~~ The high-frequency current suppressor may be consisting of composite magnetic material which comprises soft magnetic powder obtained by flattening alloy powder including at least Fe, Si, Al, and binding material.

~~As described in claim 18, the~~ The high-frequency current suppressor may be consisting of composite magnetic material which comprises soft magnetic powder obtained by flattening alloy powder including at least Ni, Fe, and binding material.

~~As described in claim 19, the~~ The high-frequency current suppressor may be consisting of magnetic loss thin film which comprises a first member consisting of at least any one of Fe, Co, Ni, or mixture thereof and a second member consisting of insulating material including at least more than one kinds of elements other than Fe, Co, Ni.